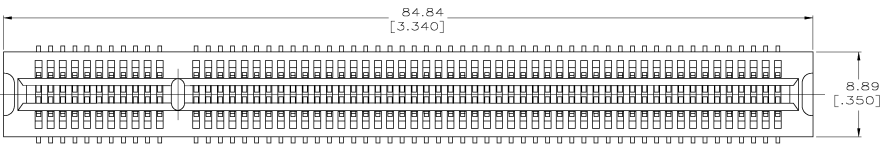
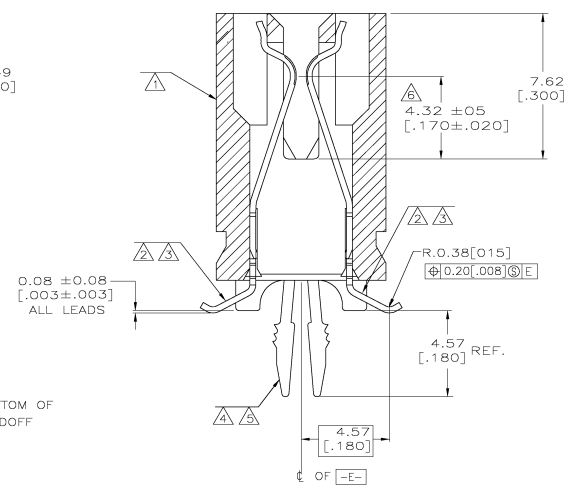
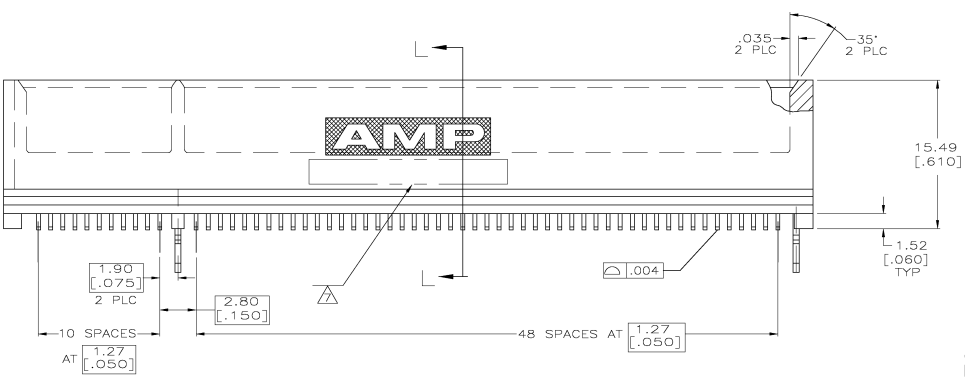


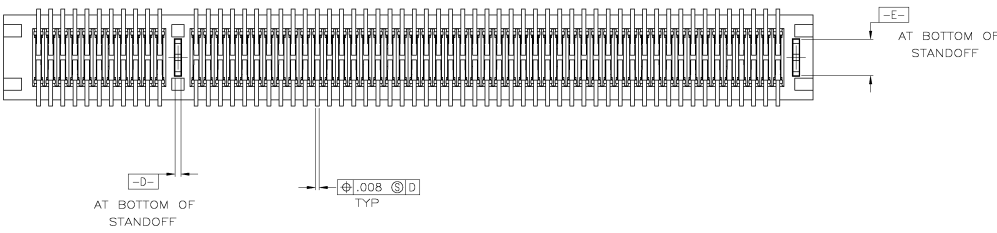
REV	DATE	DESCRIPTION	BY	CHK	APP
00		ISSUE FOR PRODUCTION			
01		REVISED PER EC: 0815-0122-05			



- △ HOUSING: HIGH TEMPERATURE THERMOPLASTIC.
- △ CONTACT: PHOSPHOR BRONZE.
- △ CONTACT FINISH: .000100 MIN NICKEL ALL OVER, .000030 MIN GOLD OVER NICKEL IN CONTACT AREA, .000100 MIN MATTE TIN OVER NICKEL ON SOLDER TAILS.
- △ METAL HOLD DOWN: BRASS
- △ METAL HOLD DOWN FINISH: .000050 MIN NICKEL ALL OVER, .000150 MIN MATTE TIN ALL OVER.
- △ DISTANCE FROM CONTACT POINT TO BOTTOM OF CARD SLOT.
- △ AMP PART NUMBER, DATE CODE AND CSA LOGO MARKED IN APPROXIMATE AREA SHOWN.

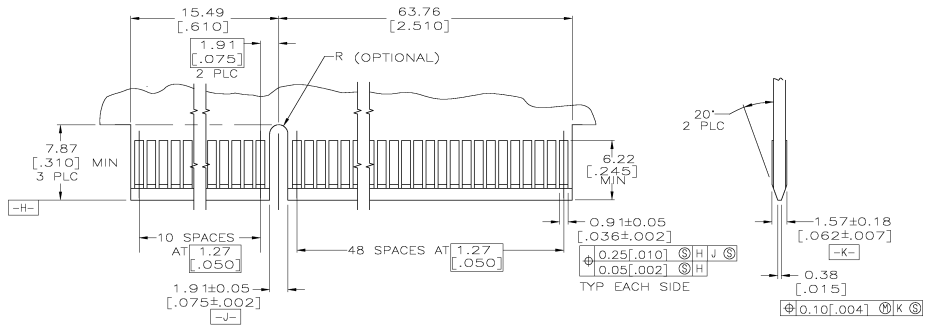


SECTION L-L
 SCALE 8:1

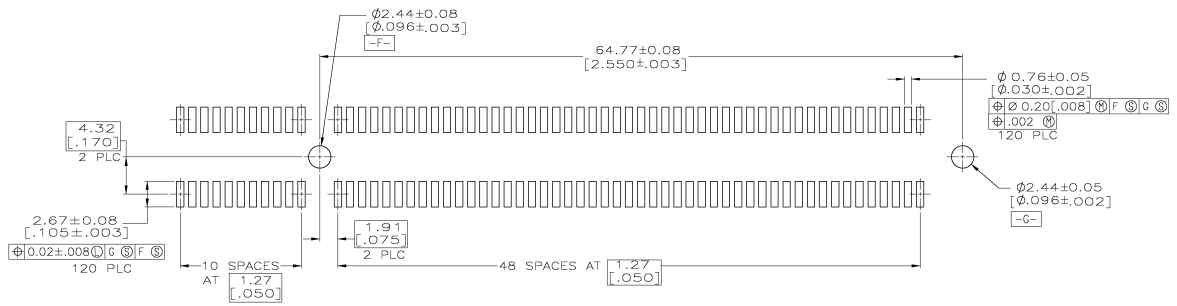


1761842-1 AS SHOWN

THIS DRAWING IS A CONTROLLED DOCUMENT.		REV. 00	DATE 08 MAR 93	TYPE	Customer Drawing
UNLESS OTHERWISE SPECIFIED:		UNIT	mm	SCALE	AS SHOWN
FINISH	AS SHOWN	STANDARD	AS SHOWN	DATE	10B-14034
DR	10B-14034	REV	114-13148	SIZE	A
DATE	114-13148	ISSUE NO.	1761842	REFLECTED TO	
ISSUE	1761842	REV	1	REV	2



RECOMMENDED MATING BOARD EDGE CONFIGURATION



RECOMMENDED PC BOARD PATTERN
(CONNECTOR SIDE SHOWN)

THIS DRAWING IS A CONTROLLED DOCUMENT.		REV. 00	DATE 30 MAR 83	Avnet	Typis Electronics Corporation
UNAPPROVED		REV. 00	DATE 30 MAR 83	Avnet	Harrisburg, Pa 17105-3608
UNITS: mm	SYMBOLS: UNLESS OTHERWISE SPECIFIED	PROJECT SIZE	10B-14034	CONNECTOR ASSEMBLY, 60 DUAL POSITION, 050 SERIES, STANDARD EDGE, SURFACE MOUNT	
SCALE: 1:1	PROJ. NO. 114-1314R	REV. 00	DATE 30 MAR 83	DRAWING NO. 100779	REV. 00
MATERIAL:	FINISH:	WEIGHT:	114-1314R	SEE 100779	REV. 00
CUSTOMER DRAWING		REV. 00	DATE 30 MAR 83	DRAWING NO. 100779	REV. 00